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FDMS7656AS N-Channel PowerTrench[®] SyncFET[™] 30 V, 49 A, 1.8 mΩ

Features

- Max $r_{DS(on)}$ = 1.8 m Ω at V_{GS} = 10 V, I_D = 30 A
- Max $r_{DS(on)}$ = 1.9 m Ω at V_{GS} = 7 V, I_D = 27 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

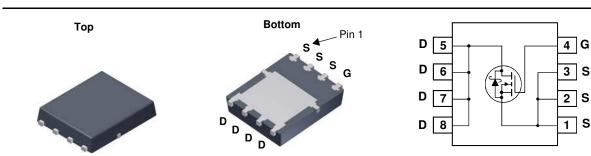


General Description

The FDMS7656AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			30	V		
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V		
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		49			
	-Continuous (Silicon limited)	T _C = 25 °C		194			
	-Continuous	T _A = 25 °C	(Note 1a)	31	Α		
	-Pulsed			180			
dv/dt	MOSFET dv/dt			1.3	V/ns		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	242	mJ		
P _D	Power Dissipation	T _C = 25 °C		96			
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5			
TJ, T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

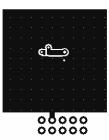
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7656AS	FDMS7656AS	Power 56	13 "	12 mm	3000 units

October 2014

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
	cteristics			-76			
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{.1}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}, \text{ referenced to } 25 \text{ °C}$		19		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			500	μA	
I _{GSS}	Gate to Source Leakage Current, Forward				100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.6	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C	
, i	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 30 A		1.3	1.8	- mΩ	
r _{DS(on)}		$V_{GS} = 7 \text{ V}, I_D = 27 \text{ A}$		1.5	1.9		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		1.6	2.0		
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125 °C		1.8	2.5	1	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 30 A		161		S	
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	- V _{DS} = 15 V, V _{GS} = 0 V, - f = 1 MHz		6545 2465 210 0.5	8705 3280 315 1.1	pF pF pF	
•	Characteristics	· · · · ·				1	
t _{d(on)}	Turn-On Delay Time			22	35	ns	
t _r	Rise Time	V _{DD} = 15 V, I _D = 30 A,		12	21	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		50	80	ns	
t _f	Fall Time			7	13	ns	
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		95	133	nC	
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V},$		43	60	nC	
Q _{gs}	Gate to Source Charge	I _D = 30 A		18.2		nC	
Q _{gd}	Gate to Drain "Miller" Charge			9.1		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.37	0.7	V	
		$V_{GS} = 0 V, I_S = 30 A$ (Note 2)		0.74	1.2		
t _{rr}	Reverse Recovery Time			50	81	ns	
Q _{rr}	Reverse Recovery Charge	I _F = 30 A, di/dt = 300 A/μs		84	136	nC	



a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



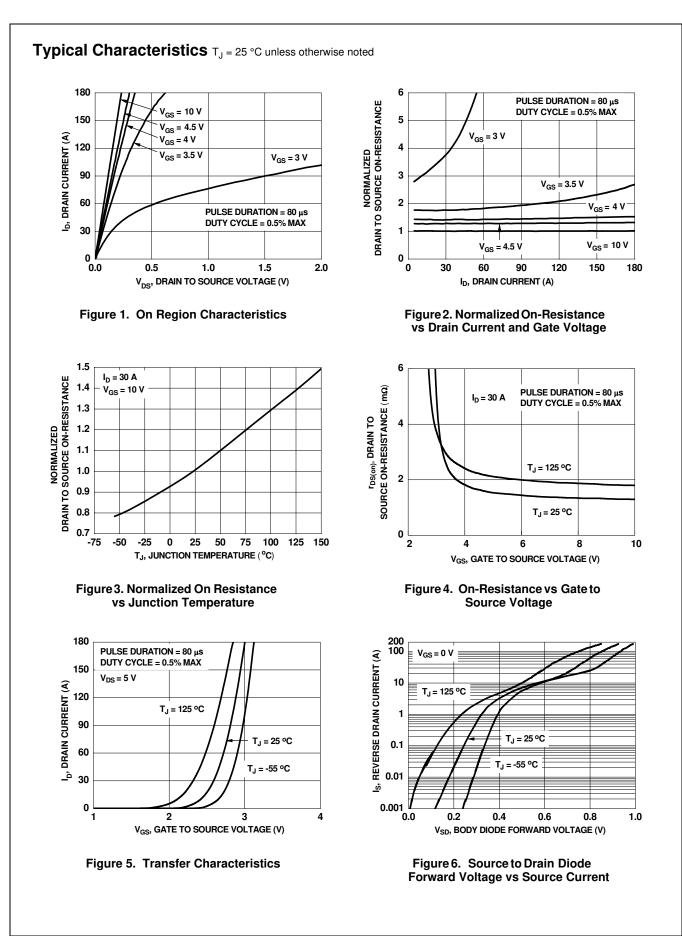
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. E_{AS} of 242 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 22 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 34 A.

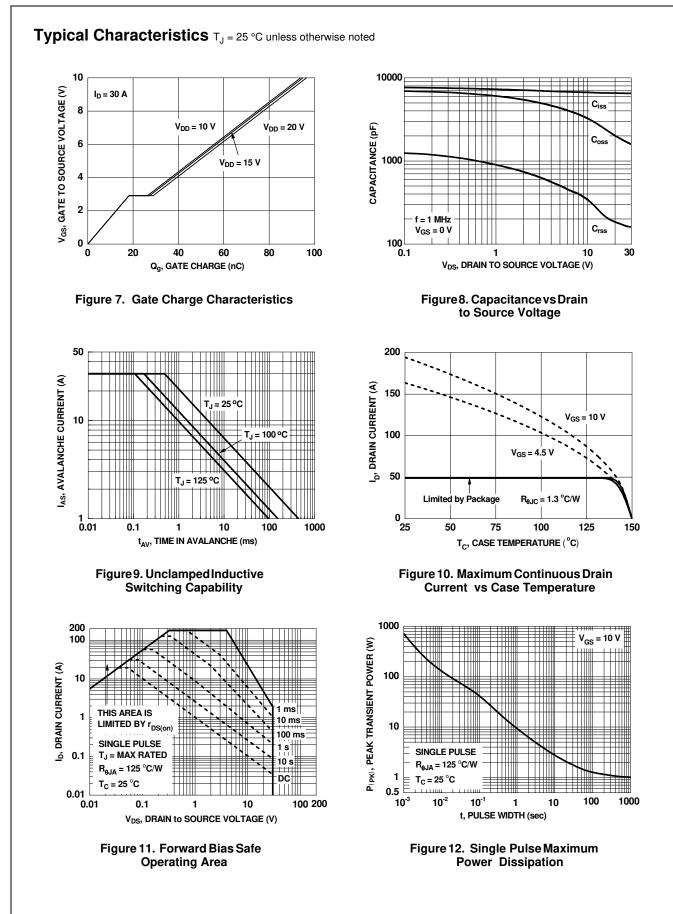
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

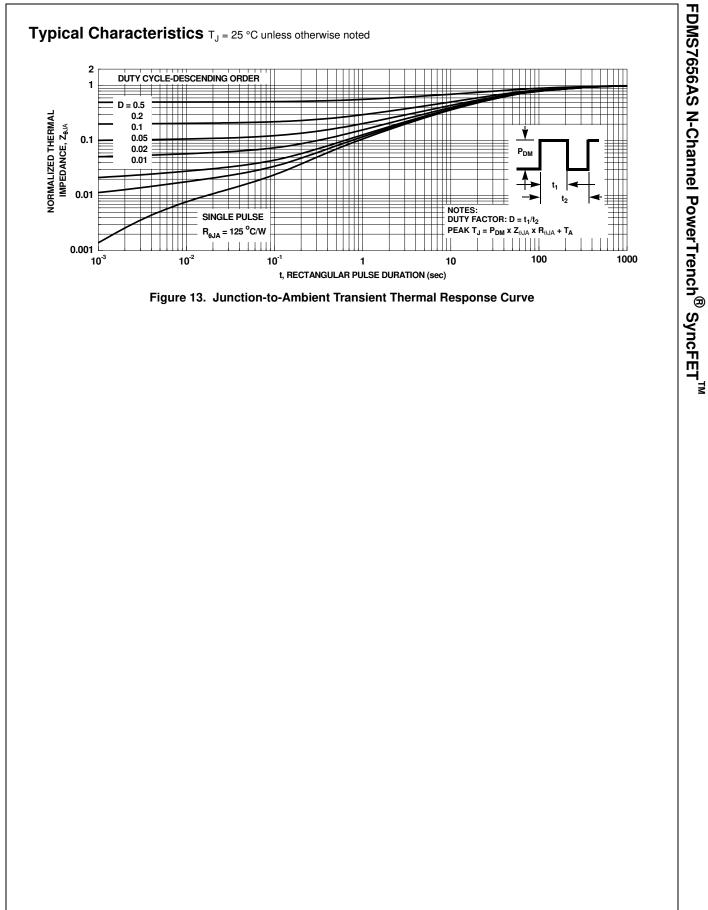
FDMS7656AS Rev.C2

FDMS7656AS N-Channel PowerTrench[®] SyncFET[™]









Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7656AS.

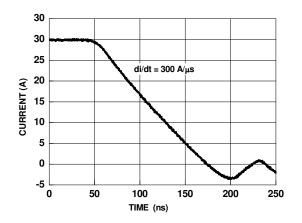


Figure 14. FDMS7656AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

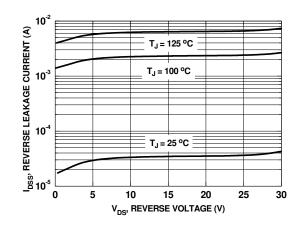
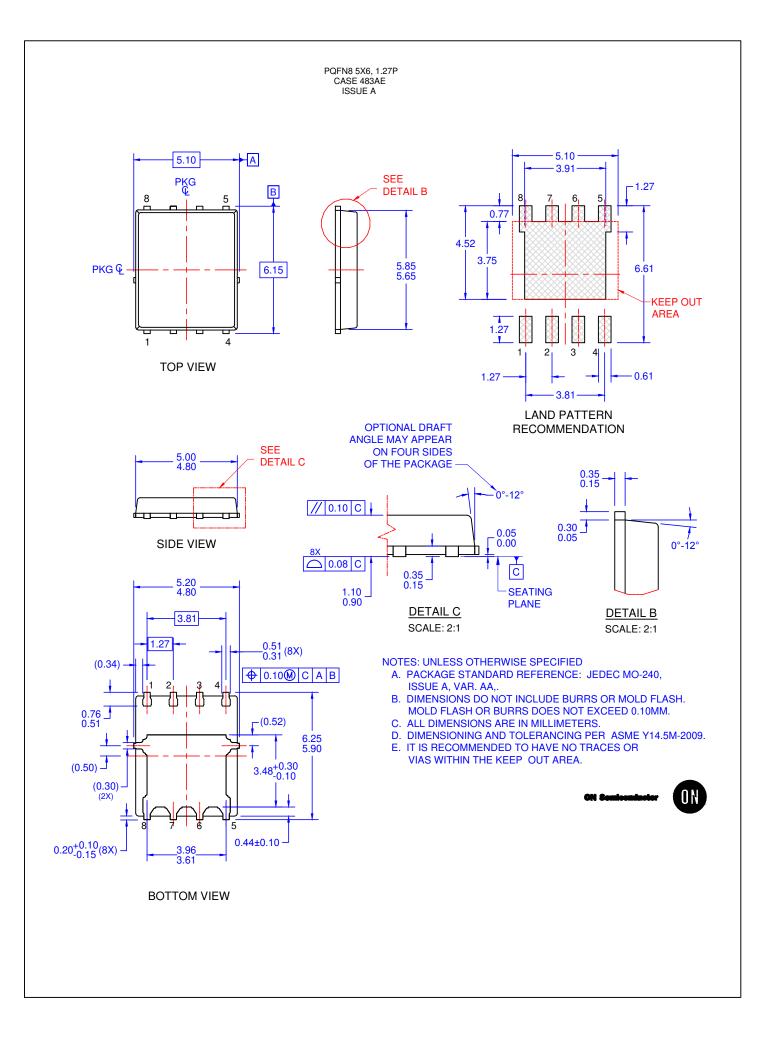


Figure 15. SyncFET body diode reverses leakage versus drain-source voltage



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